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ATTORNEY DOCKET NO. APPLICATION NO. FIRST NAMED INVENTOR **FILING DATE** Τ 98-0645.1 **JIANG** 09/258.961 03/01/99 **EXAMINER** MMC1/0426 PAREKH, N STEPHEN A GRATTON 2764 SOUTH BRAUN WAY ART UNIT PAPER NUMBER LAKEWOOD CO 80228 2811 DATE MAILED: 04/26/00

Please find below and/or attached an Office communication concerning this application or proceeding.

**Commissioner of Patents and Trademarks** 

1- File Copy

Application No. 09/258,961

Applicant(s)

Jiang et al

## Office Action Summary

Examiner

Nitin Parekh

Group Art Unit 2811



X Responsive to communication(s) filed on Mar 1, 1900	·
☐ This action is <b>FINAL</b> .	
Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11; 453 O.G. 213.	
A shortened statutory period for response to this action is set to e is longer, from the mailing date of this communication. Failure to application to become abandoned. (35 U.S.C. § 133). Extensions 37 CFR 1.136(a).	respond within the period for response will cause the
Disposition of Claims	
	is/are pending in the application.
Of the above, claim(s)	is/are withdrawn from consideration.
☐ Claim(s)	is/are allowed.
Claim(s)	
☐ Claims	
Application Papers	
$\square$ See the attached Notice of Draftsperson's Patent Drawing F	Review, PTO-948.
☐ The drawing(s) filed on is/are objected	to by the Examiner.
☐ The proposed drawing correction, filed on	is 🗖 approved 🗖 disapproved.
$\hfill\Box$ The specification is objected to by the Examiner.	
$\hfill\Box$ The oath or declaration is objected to by the Examiner.	
Priority under 35 U.S.C. § 119	
Acknowledgement is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d).	
☐ All ☐ Some* ☐ None of the CERTIFIED copies of the priority documents have been	
☐ received.	
received in Application No. (Series Code/Serial Number)	
$\square$ received in this national stage application from the International Bureau (PCT Rule 17.2(a)).	
*Certified copies not received:	
☐ Acknowledgement is made of a claim for domestic priority	under 35 U.S.C. § 119(e).
Attachment(s)	
Notice of References Cited, PTO-892	
	s). <u>2</u>
☐ Interview Summary, PTO-413	
□ Notice of Draftsperson's Patent Drawing Review, PTO-948	•
☐ Notice of Informal Patent Application, PTO-152	
SEE OFFICE ACTION ON THE FOLLOWING PAGES	

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## **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 24-36 are rejected under 35 U.S.C. 103(a) as being unpatentable over the admitted prior art (Fig. 7) in view of Lee et al (US Pat. 5796586).
- Regarding claim 24, the admitted prior art (Fig.1A and B; pages 2-4) et al discloses substrate for fabricating a semiconductor package comprising:
- a plurality of conductors formed on a first surface of the substrate, the conductors comprising a plurality of ball bonding pads
- a first mask formed on the first surface of the substrate comprising a plurality of via openings to the ball bonding pads, and
- a second mask substantially covering a second surface of the substrate and including an opening defining an opening for wire bonding area.

The admitted prior art fails to specify the opening in the second mask to define the die attached area. Lee et al teaches defining an opening through the mask on the substrate and bonding the die to the die attach area corresponding to the outline of the die to improve the adhesion of die and to

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prevent subsequent lift-off problems during rework/repair applications near the die attach area (Fig. 7 and Fig. 1-6; Col. 1-8). The cited reference by Akram et al (US Pat. 5739585) teaches the fabrication of a ball grid array (BGA) package using a variety of substrates and specifies an opening in the second mask defining the die attach area on the substrate (Fig. 4D, 4E and Fig. 1-10; Col. 7). Therefore, it would have been obvious to the person of ordinary skill in the art at the time invention was made to use a second mask substantially covering a second surface of the substrate and including an opening defining an opening defining a die attach area and adhesively bonding the die to the area corresponding to the outline of the die to prevent the lift-off related problems during rework/repair applications using Lee et al's teachings in the admitted prior art as cited in claims 24-26.

Claims 27-29 are rejected over the admitted prior art (Fig. 1A and B; pages 2-4) in view of Lee et al (Fig. 1-7; Col. 1-8). and as explained above for claim 24-26.

Claims 30-33 are rejected over the admitted prior art (Fig. 1A and B; pages 2-4) in view of Lee et al (Fig. 1-7; Col. 1-8) and as explained above for claims 24-26.

Claims 34-36 rejected over the admitted prior art (Fig. 1A and B; pages 2-4) in view of Lee et al (Fig. 1-7; Col. 1-8) and as explained above for claims 28, 30, 31 and 33.

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Papers related to this application may be submitted directly to Art Unit 2811 by facsimile transmission. Papers should be faxed to Art Unit via Technology Center 2800 fax center located in Crystal Plaza 4, room 4C23. The faxing of such papers must conform with the notice published in the Official Gazette, 1096 OG 30 (15 November 1989).

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Nitin Parekh whose telephone number in (703) 305-3410. The examiner can be normally reached on Monday-Friday from 08:30 am-5:00 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas, can be reached on (703) 308-2772. The fax number for the organization where this application or proceeding is assigned is (703) 308-7722 or 7724.

Nitin Parekh

04-21-2000

Tom Thomas
Supervisory Patent Examiner

Technology Center 2800